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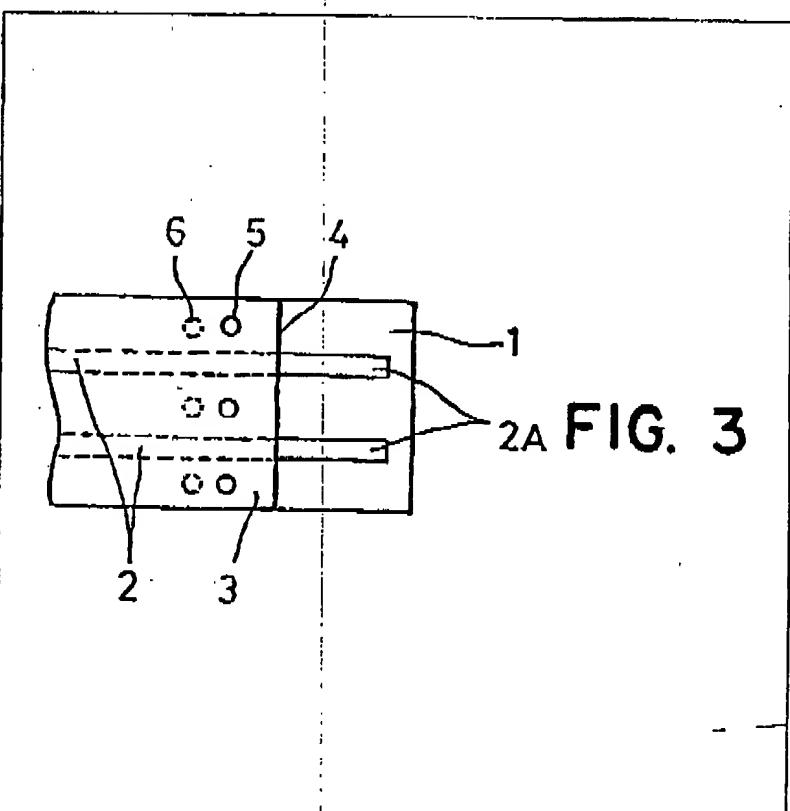
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(54) Flexible circuit board

(57) A flexible circuit board comprises
a base film 1 with a circuit pattern 2
theron, a cover film 3 over part of the
circuit pattern which leaves anexposed connection portion 2A of the
circuit pattern, and stress relief
apertures 5, 6 in the cover film and/or
the base film adjacent the edge 4 of
the cover film to prevent stress
concentrations which cause breaking
of the circuit pattern.

mention les
types de reliefs



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